

May 2015

FQU5N50CTU_WS

N-Channel QFET $^{\rm @}$ MOSFET 500 V, 4.0 A, 1.4 Ω

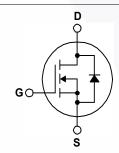
Features

- 4.0 A, 500 V, $R_{DS(on)} = 1.4 \Omega @V_{GS} = 10 V$
- Low Gate Charge (Typ. 18 nC)
- Low Crss (Typ. 15 pF)
- Fast Switching
- 100% Avalanche Tested
- · Improved dv/dt Capability

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQU5N50CTU_WS	Units
V _{DSS}	Drain-Source Voltage		500	V
I _D	Drain Current - Continuous (T _C = 25°C)		4.0	Α
	- Continuous (T _C = 100°C)		2.4	А
I _{DM}	Drain Current - Pulsed	(Note 1)	16	Α
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	300	mJ
I _{AR}	Avalanche Current	(Note 1)	4	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	4.8	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns
P_{D}	Power Dissipation (T _C = 25°C)		48	W
	- Derate above 25°C		0.38	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	
'L			300	°C

Thermal Characteristics

Symbol	Parameter	FQU5N50CTU_WS	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	2.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	110	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQU5N50CTU_WS	FQU5N50CS	I-PAK	Tube	N/A	N/A	75 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$				V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.5		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 500 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 400 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 2.0 A		1.14	1.4	Ω
g _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 2.0 A		5.2		S
C _{iss}	Input Capacitance Output Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$		480 80	625 105	pF pF
	c Characteristics			490	625	ηE
C	Reverse Transfer Capacitance	f = 1.0 MHz		15	20	pF pF
C _{rss}	Reverse Transfer Capacitance			15	20	рг
Switchi	ng Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 250 V, I _D = 5 A,		12	35	ns
t _r	Turn-On Rise Time	$V_{GS} = 10 \text{ V, } R_{G} = 25 \Omega$		46	100	ns
t _{d(off)}	Turn-Off Delay Time	VGS 10 V, NG 20 12		50	110	ns
t _f	Turn-Off Fall Time	(Note 4)	/	48	105	ns
Qg	Total Gate Charge	V _{DS} = 400 V, I _D = 5 A,		18	24	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		2.2		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		9.7		nC
	ource Diode Characteristics and	Maximum Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				4	Α
I _{SM}	Maximum Pulsed Drain-Source Diode For				16	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 4 A			1.4	V
			1			

Q_{rr}

 t_{rr}

1. Repetitive rating : pulse width limited by maximum junction temperature.

Reverse Recovery Charge

2. L = 21.5 mH, I $_{AS}$ = 5 A, V $_{DD}$ = 50 V, R $_{G}$ = 25 Ω , starting T $_{J}$ = 25°C.

Reverse Recovery Time

- 3. $I_{SD} \le 5$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, starting $T_J = 25$ °C.
- 4. Essentially independent of operating temperature.

ns

μC

263

1.9

(Note 4)

 $V_{GS} = 0 \text{ V}, I_{S} = 5 \text{ A},$

 $dI_F / dt = 100 A/\mu s$

Typical Characteristics

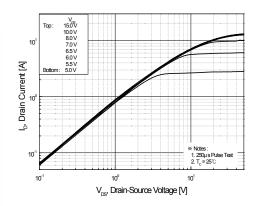


Figure 1. On-Region Characteristics

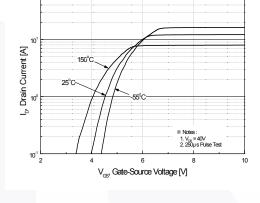


Figure 2. Transfer Characteristics

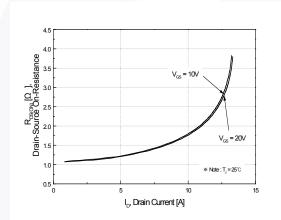


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

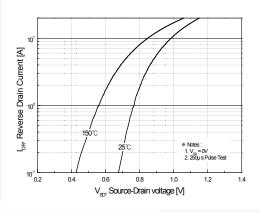


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

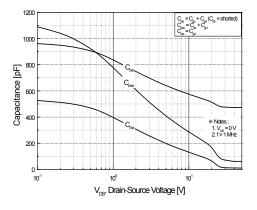


Figure 5. Capacitance Characteristics

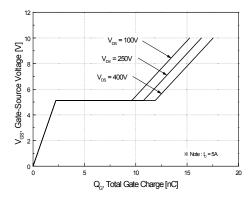


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

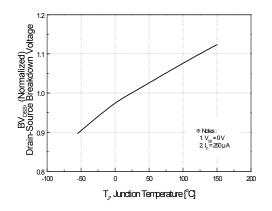


Figure 7. Breakdown Voltage Variation vs Temperature

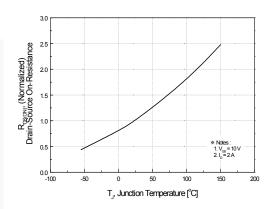


Figure 8. On-Resistance Variation vs Temperature

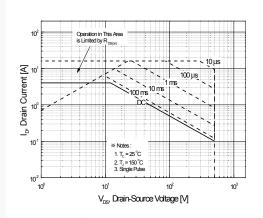


Figure 9. Maximum Safe Operating Area

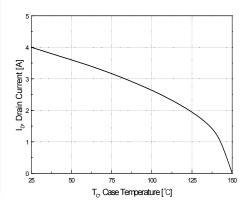


Figure 10. Maximum Drain Current vs Case Temperature

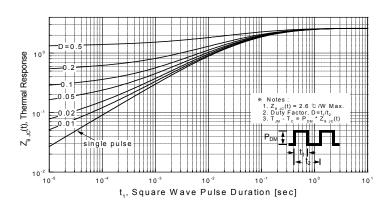


Figure 11. Transient Thermal Response Curve

Figure 12. Gate Charge Test Circuit & Waveform

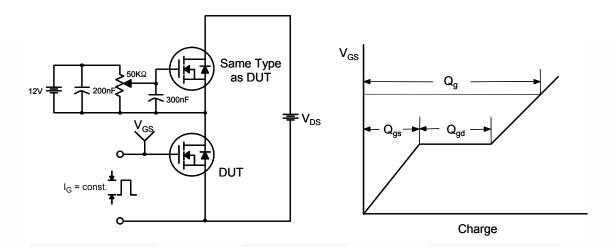


Figure 13. Resistive Switching Test Circuit & Waveforms

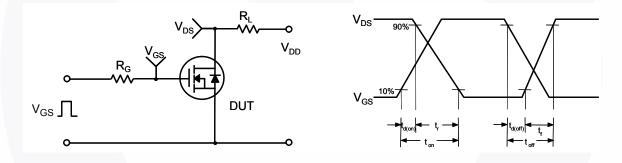
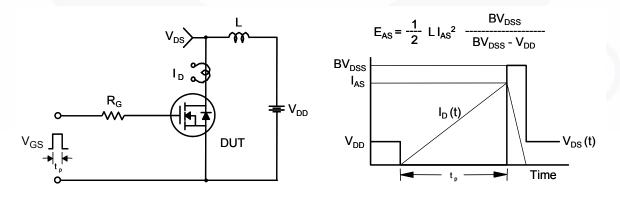


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



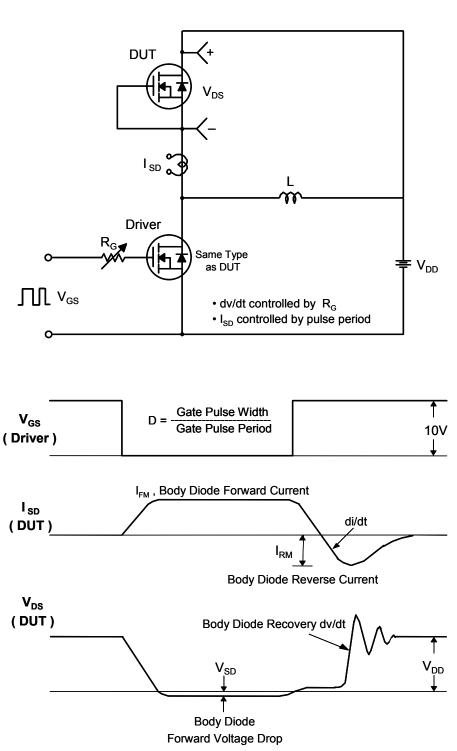
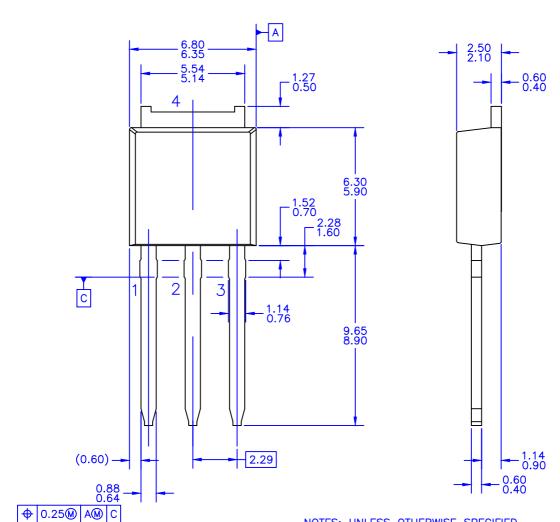
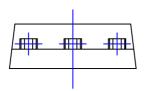


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms





3 PLCS

NOTES: UNLESS OTHERWISE SPECIFIED

- ALL DIMENSIONS ARE IN MILLIMETERS.
- B) THIS PACKAGE CONFORMS TO JEDEC, TO-251, ISSUE C, VARIATION AA, DATED SEP 1988.
 C) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- DRAWING NUMBER AND REVISION: MKT-T0251A03REV2 D)









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